

# Sn97/Cu3 LEAD FREE SOLDER

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### **Physical Properties**

#### **Solder Composition**

Qualitek Sn97/Cu3 is a high temperature lead-free alloy. The Qualitek Sn97/Cu3 alloy conforms and exceeds the impurity requirements of J-Std-006 and all other relevant international standards.

Typical Analysis													
Sn	Cu	Ag	Pb	Sb	Bi	In	As	Fe	Ni	Cd	Al	Zn	Au
Bal	2.7-	0.030	0.050	0.050	0.050	0.050	0.010	0.010	0.005	0.001	0.001	0.001	0.002
	3.3	Max											

	Sn97Cu03
Melting Point, ° C	227-320
Hardness, Brinell	11HB
Coefficient of Thermal Expansion	Pure Sn= 23.5
Density, g/cc	7.34

## Handling & Storage

Solder bar storage should be in a 65-80°F environment away from direct heat. When directly handling solder bar it is recommend to use appropriate gloves. Solder bar has an indefinite shelf life.

#### Packaging

Sn97Cu3 solder bars are available in

Box of 20-2.2lb bar (1 kg) Kilobar Box of 5-11 lb bars (kg) Equalizer